

> **Features**

- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- Avalanche Rated

> **Applications**

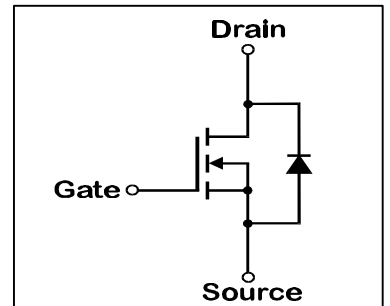
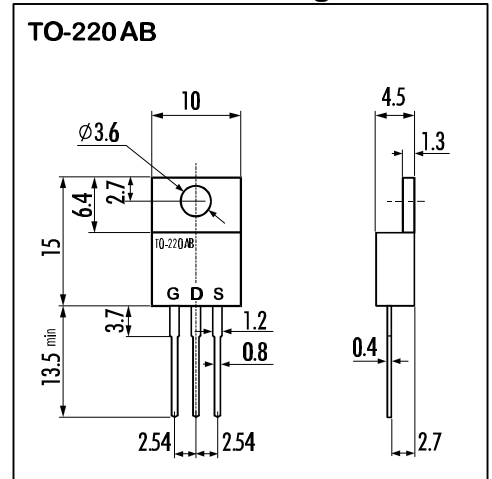
- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

> **Maximum Ratings and Characteristics**

- Absolute Maximum Ratings (T_C=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V _{DS}	700	V
Continous Drain Current	I _D	±5	A
Pulsed Drain Current	I _{D(puls)}	±20	A
Gate-Source-Voltage	V _{GS}	±30	V
Maximum Avalanche Energy	E _{AV}	222.8	mJ*
Max. Power Dissipation	P _D	60	W
Operating and Storage Temperature Range	T _{ch}	150	°C
	T _{stg}	-55 ~ +150	°C

> **Outline Drawing**



- Electrical Characteristics (T_C=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	BV _{DSS}	I _D =1mA V _{GS} =0V	700			V
Gate Threshold Voltage	V _{GS(th)}	I _D =1mA V _{DS} =V _{GS}	2,5	3,0	3,5	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =700V T _{ch} =25°C		10	500	μA
		V _{GS} =0V T _{ch} =125°C		0,2	1,0	mA
Gate Source Leakage Current	I _{GSS}	V _{GS} =±30V V _{DS} =0V		10	100	nA
Drain Source On-State Resistance	R _{DS(on)}	I _D =2,5A V _{GS} =10V		1,4	1,85	Ω
Forward Transconductance	g _{fs}	I _D =2,5A V _{DS} =25V	2	4		S
Input Capacitance	C _{iss}	V _{DS} =25V		820	1230	pF
Output Capacitance	C _{oss}	V _{GS} =0V		120	180	pF
Reverse Transfer Capacitance	C _{rss}	f=1MHz		65	100	pF
Turn-On-Time t _{on} (t _{on} =t _{d(on)} +t _r)	t _{d(on)}	V _{CC} =600V		20	30	ns
	t _r	V _{GS} =10V		45	70	ns
	t _f	I _D =5A R _{GS} =10 Ω		80	120	ns
Turn-Off-Time t _{off} (t _{off} =t _{d(off)} +t _f)	t _{d(off)}			45	70	ns
	t _f			45	70	ns
				45	70	ns
Avalanche Capability	I _{AV}	L = 100μH T _{ch} =25°C	5			A
Diode Forward On-Voltage	V _{SD}	I _F =2 X I _{DR} V _{GS} =0V T _{ch} =25°C		0,93	1,4	V
Reverse Recovery Time	t _{rr}	I _F =I _{DR} V _{GS} =0V		610		ns
Reverse Recovery Charge	Q _{rr}	-di/dt=100A/μs T _{ch} =25°C		5,5		μC

- Thermal Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance	R _{th(ch-c)}			2,08	°C/W
	R _{th(ch-a)}			75,0	°C/W

N-channel MOS-FET			
700V	1,85Ω	±5A	60W

2SK2695-01

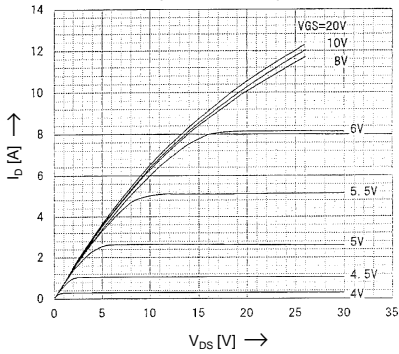
FAP-IIIB Series



> Characteristics

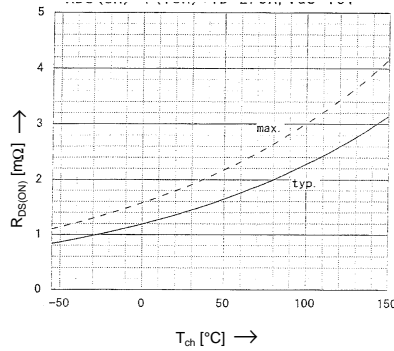
Typical Output Characteristics

$I_D = f(V_{DS})$; 80μs pulse test; $T_{ch} = 25^\circ\text{C}$



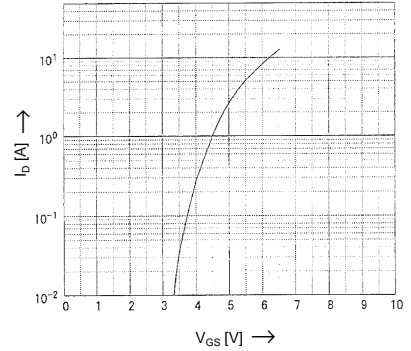
Drain-Source On-State Resistance vs. T_{ch}

$R_{DS(on)} = f(T_{ch})$; $I_D = 2.5\text{A}$; $V_{GS} = 10\text{V}$



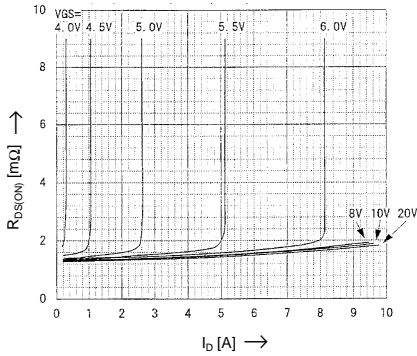
Typical Transfer Characteristics

$I_D = f(V_{GS})$; 80μs pulse test; $V_{DS} = 25\text{V}$; $T_{ch} = 25^\circ\text{C}$



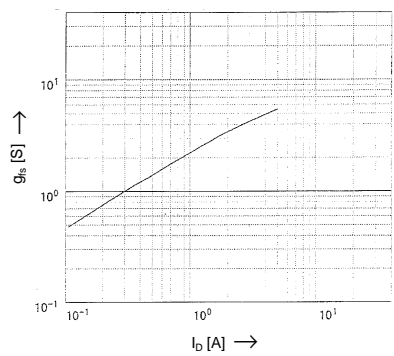
Typical Drain-Source On-State-Resistance vs. I_D

$R_{DS(on)} = f(I_D)$; 80μs pulse test; $T_{ch} = 25^\circ\text{C}$



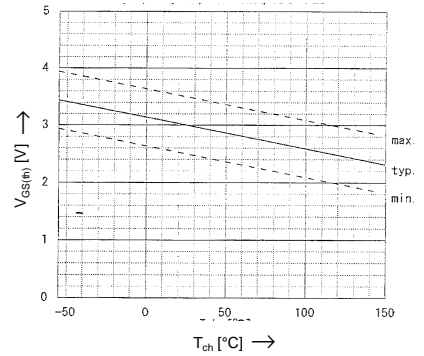
Typical Forward Transconductance vs. I_D

$g_{fs} = f(I_D)$; 80μs pulse test; $V_{DS} = 25\text{V}$; $T_{ch} = 25^\circ\text{C}$



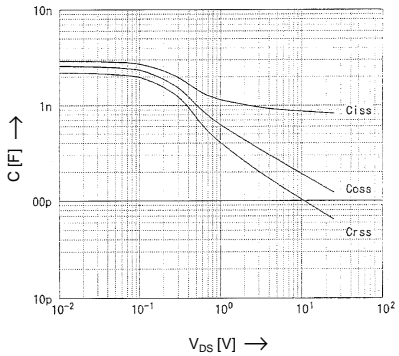
Gate Threshold Voltage vs. T_{ch}

$V_{GS(th)} = f(T_{ch})$; $I_D = 1\text{mA}$; $V_{DS} = V_{GS}$



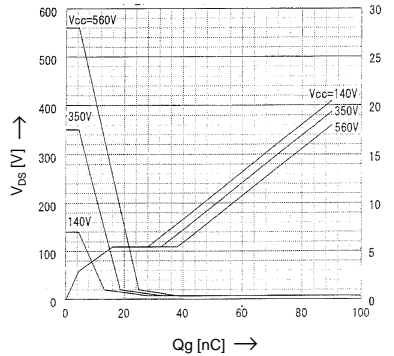
Typical Capacitances vs. V_{DS}

$C = f(V_{DS})$; $V_{GS} = 0\text{V}$; $f = 1\text{MHz}$



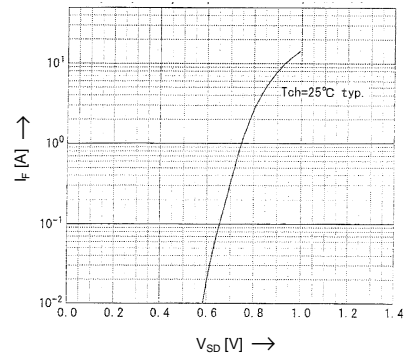
Typical Gate Charge Characteristic

$V_{GS} = f(Q_g)$; $I_D = 5\text{A}$; $T_{ch} = 25^\circ\text{C}$



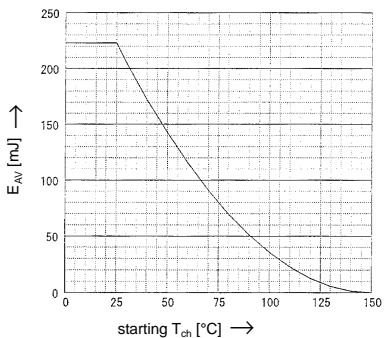
Forward Characteristics of Reverse Diode

$I_F = f(V_{SD})$; 80μs pulse test; $V_{GS} = 0\text{V}$



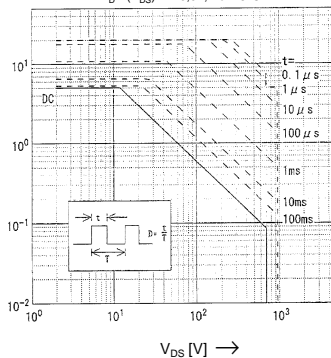
Maximum Avalanche Energy vs. starting T_{ch}

$E_{AV} = f(\text{starting } T_{ch})$; $V_{CC} = 24\text{V}$; $I_{AV} \leq 45\text{A}$



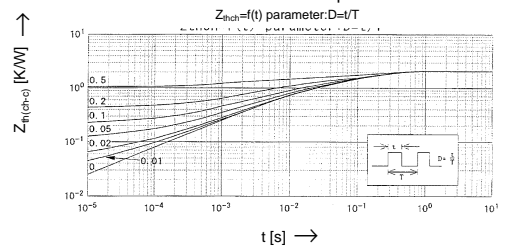
Safe Operation Area

$I_D = f(V_{DS})$; $D = 0.01$; $T_{ch} = 25^\circ\text{C}$



Transient Thermal Impedance

$Z_{th(ch-c)} = f(t)$ parameter: $D \sim t$



N-channel MOS-FET			
700V	1,85Ω	±5A	60W

2SK2695-01

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> Characteristics

